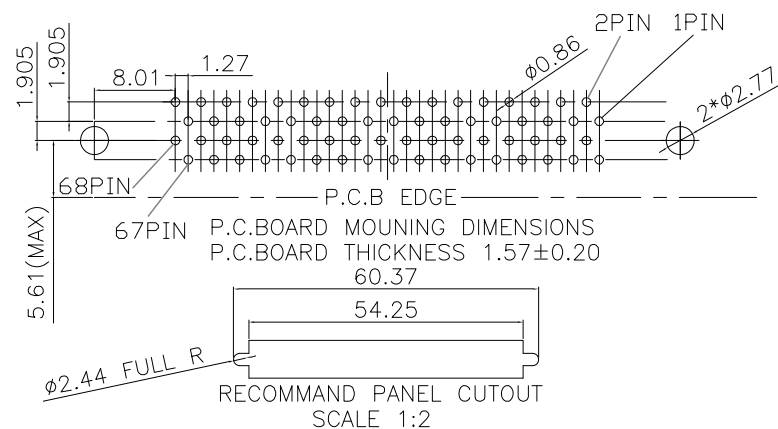
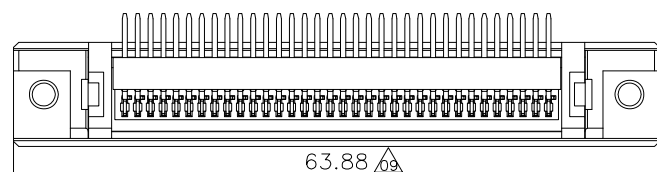
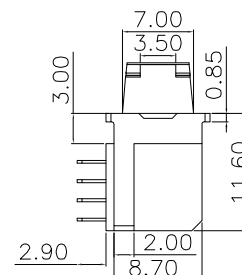
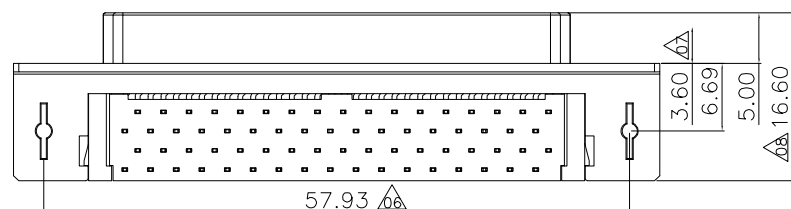


SECTION A-A



NOTES:

1.ELECTRICAL:

2.1 CONTACT RESISTANCE :25mΩ MAX

2.2 WITHSTANDING VOLTAGE :500V AC FOR ONE MINUTE

2.3 INSULATION RESISTANCE :1000MΩ MIN

2.4 VOLTAGE CURRENT RATING :3.00 AMP

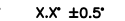
2. ENVIRONMENTAL:

3.1 OPERAION TEMPERATURE: $-55^{\circ}\text{C}^{\wedge}+125^{\circ}\text{C}$

⑤	BOARD LOCK	BRASS	2.5um Tin plated over 1.25um nickel under-plating	2	
④	CONTACT	C5191-H	(Pd+Au)0.375um Au plated on Contact Area, 2.5um Tin plated on soldering end, over 1.25um nickel under-plating	68	
③	BRACKET	ZINC ALLOY	1.25um nickel plated	1	SALT 48H
②	COVER	PBT+30%G/F	_____	1	BLACK
①	HOUSING	PBT+30%G/F	_____	1	BLACK
ITEM	DESCRIPTIONS	MATERIAL	FINISH	Q'TY	NOTE



深圳市华宇创精密电子有限公司

TOLERANCE:		DRAWN BY : 陈一鸣	DATE : 2014-02-23	PART NAME:	
X.X ±0.30 X.XX ±0.25 X.XXX ±0.15 X.* ±2* X.X* ±0.5*				SCSI 68P DIP TYPE	
		CHECKED BY:	DATE :	PART NO.	HVC20-SCSI68-254
		马跃	2014-02-23	MOLD NO.	
UNIT: mm [inch]		APPROVED BY:	DATE :	DRAW NO:	HVC-1804100925
SCALE:1:1	SIZE: A4	柯南	2014-02-23	SHEET NO.	1 OF 1